

54F/74F273 **Octal D Flip-Flop**

General Description

The 'F273 has eight edge-triggered D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) and Master Reset (\overline{MR}) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one setup time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's Q out-

All outputs will be forced LOW independently of Clock or Data inputs by a LOW voltage level on the MR input. The device is useful for applications where the true output only is required and the Clock and Master Reset are common to all storage elements.

Features

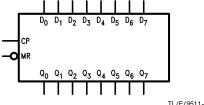
- Ideal buffer for MOS microprocessor or memory
- Eight edge-triggered D flip-flops
- Buffered common clock
- Buffered, asynchronous Master Reset
- See 'F377 for clock enable version
- See 'F373 for transparent latch version
- See 'F374 for TRI-STATE® version
- Guaranteed 4000V minimum ESD protection

Commercial	Military	Package Number	Package Description		
74F273PC		N20A	20-Lead (0.300" Wide) Molded Dual-In-Line		
	54F273DM (Note 2)	J20A	20-Lead Ceramic Dual-In-Line		
74F273SC (Note 1)		M20B	20-Lead (0.300" Wide) Molded Small Outline, JEDEC		
74F273SJ (Note 1)		M20D	20-Lead (0.300" Wide) Molded Small Outline, EIAJ		
	54F273FM (Note 2)	W20A	20-Lead Cerpack		
	54F273LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C		

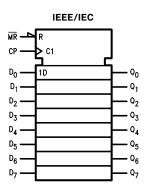
Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

Logic Symbols



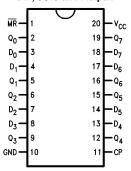
TL/F/9511-3

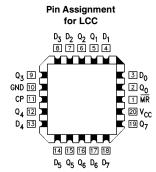


TL/F/9511-5

Connection Diagrams

Pin Assignment for DIP, SOIC and Flatpak





TL/F/9511-2

TL/F/9511-1

Unit Loading/Fan Out

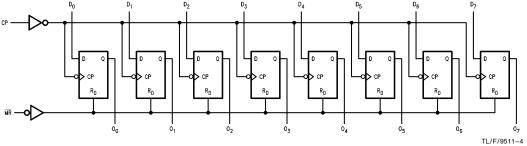
		54F/74F			
Pin Names	Description	U.L. HIGH/LOW	Input I _{IH} /I _{IL} Output I _{OH} /I _{OL}		
D ₀ -D ₇	Data Inputs	1.0/1.0	20 μA/-0.6 mA		
MR	Master Reset (Active LOW)	1.0/1.0	20 μA/ – 0.6 mA		
CP	Clock Pulse Input (Active Rising Edge)	1.0/1.0	20 μA/-0.6 mA		
Q_0-Q_7	Data Outputs	50/33.3	-1 mA/20 mA		

Mode Select-Function Table

Operating Mode		Output		
Operating mode	MR	СР	Dn	Qn
Reset (Clear)	L	Х	Х	L
Load '1'	Н		h	Н
Load '0'	Н		ī	L

- $\begin{array}{ll} H = HIGH\ Voltage\ Level\ steady\ state \\ h = HIGH\ Voltage\ Level\ one\ setup\ time\ prior\ to\ the\ LOW-to-HIGH\ clock \end{array}$ transition
- L = LOW Voltage Level steady state I = LOW Voltage Level one setup time prior to the LOW-to-HIGH clock
- X = Immaterial $\mathcal{L} = IOW$ -to-HIGH clock transition

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \text{Storage Temperature} & -65^{\circ}\text{C to} + 150^{\circ}\text{C} \\ \text{Ambient Temperature under Bias} & -55^{\circ}\text{C to} + 125^{\circ}\text{C} \\ \text{Junction Temperature under Bias} & -55^{\circ}\text{C to} + 175^{\circ}\text{C} \\ \text{Plastic} & -55^{\circ}\text{C to} + 150^{\circ}\text{C} \\ \end{array}$

V_{CC} Pin Potential to

Voltage Applied to Output

in HIGH State (with $V_{CC} = 0V$)

 $\begin{array}{ll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{TRI-STATE Output} & -0.5 \text{V to } +5.5 \text{V} \end{array}$

Current Applied to Output in LOW State (Max)

twice the rated I_{OL} (mA) 4000V

ESD Last Passing Voltage (min)

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

Free Air Ambient Temperature

Supply Voltage

Military + 4.5V to + 5.5V Commercial + 4.5V to + 5.5V

DC Electrical Characteristics

Symbol	Parameter		54F/74F			Units	v	Conditions	
Syllibol			Min	Тур	Max	Units	V _{CC}	Conditions	
V _{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal	
V_{IL}	Input LOW Voltage				0.8	V		Recognized as a LOW Signal	
V_{CD}	Input Clamp Diode Voltage				-1.2	V	Min	$I_{IN} = -18 \text{ mA}$	
V _{OH}	Output HIGH Voltage	Mil 10% V _{CC} 5% V _{CC}	2.5 2.5 2.7			٧	Min	$I_{OH} = -1 \text{ mA}$	
V _{OL}	Output LOW Voltage	Mil 10% V _{CC} 5% V _{CC}			0.5 0.5 0.5	V	Min	I _{OL} = 20 mA	
I _{IH}	Input HIGH Current	54F 74F			20.0 5.0	μΑ	Max	V _{IN} = 2.7V	
I _{BVI}	Input HIGH Current Breakdown Test	54F 74F			100 7.0	μΑ	Max	V _{IN} = 7.0V	
I _{CEX}	Output HIGH Leakage Current	54F 74F			250 50	μΑ	Max	V _{OUT} = V _{CC}	
V_{ID}	Input Leakage Test	74F	4.75			V	0.0	$I_{\text{ID}} = 1.9 \ \mu\text{A}$ All other pins grounded	
I _{OD}	Output Leakage Circuit Current	74F			3.75	μΑ	0.0	V _{IOD} = 150 mV All other pins grounded	
I _{IL}	Input LOW Current				-0.6	mA	Max	V _{IN} = 0.5V	
I _{OS}	Output Short-Circuit C	Current	-60		-150	mA	Max	V _{OUT} = 0V	
I _{CCH}	Power Supply Current	t .			44 56	mA	Max	$CP = \checkmark$ $D_n = \overline{MR} = HIGH$	

AC Electrical Characteristics

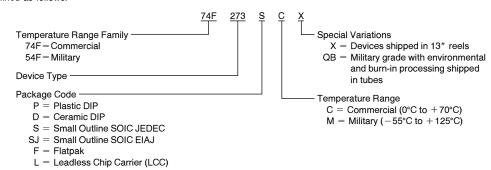
	Parameter	$74F \\ T_A = +25^{\circ}C \\ V_{CC} = +5.0V \\ C_L = 50 pF$			54F T _A , V _{CC} = Mil C _L = 50 pF		74F T _A , V _{CC} = Com C _L = 50 pF		Units
Symbol									
		Min	Тур	Max	Min	Max	Min	Max	
f _{max}	Maximum Clock Frequency	160			95		130		MHz
t _{PLH}	Propagation Delay Clock to Output	3.0 4.0		7.0 9.00	2.5 3.0	9.5 11.0	2.5 3.5	7.5 9.0	ns
t _{PLH}	Propagation Delay MR to Output	4.5		9.5	3.0	11.0	4.0	10.0	ns

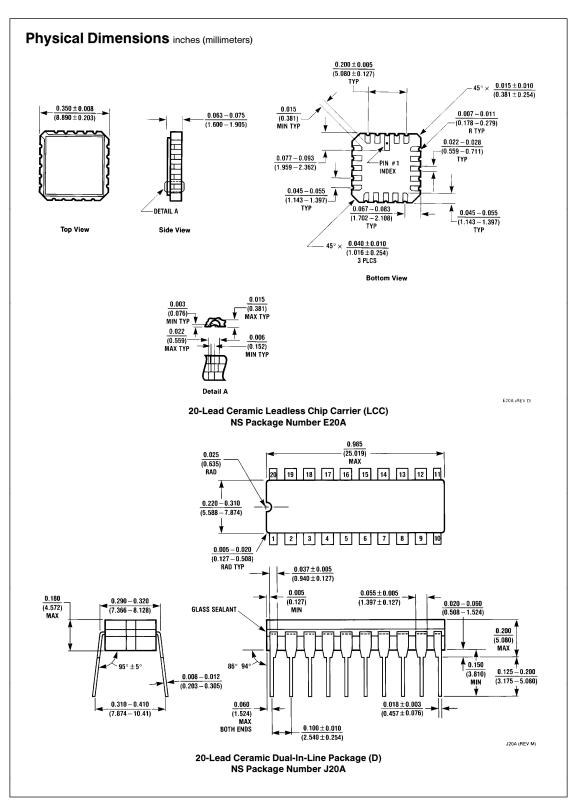
AC Operating Requirements

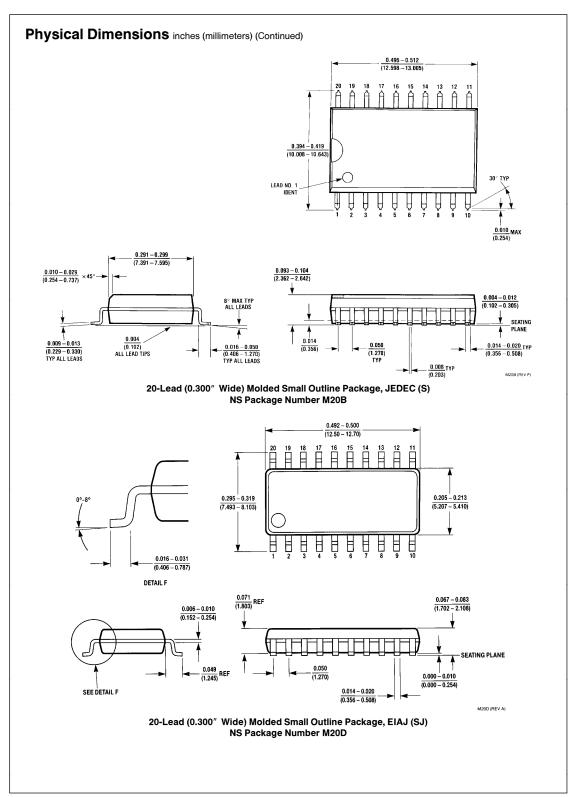
		$74F$ $T_A = +25^{\circ}C$ $V_{CC} = +5.0V$		54	F	74F T _A , V _{CC} = Com		Units
Symbol	Parameter			T _A , V _{CC}	; = Mil			
		Min	Max	Min	Max	Min	Max	
t _s (H) t _s (L)	Setup Time, HIGH or LOW Data to CP	3.0 3.5		3.5 4.0		3.0 3.5		- ns
t _h (H)	Hold Time, HIGH or LOW Data to CP	0.5 1.0		1.0 1.0		0.5 1.0		113
t _w (L)	MR Pulse Width, LOW	6.0		4.0		6.0		ns
t _w (H)	CP Pulse Width HIGH or LOW	6.0 6.0		5.0 5.0		6.0 6.0		ns
t _{rec}	Recovery Time, MR to CP	3.0		4.5		3.5		ns

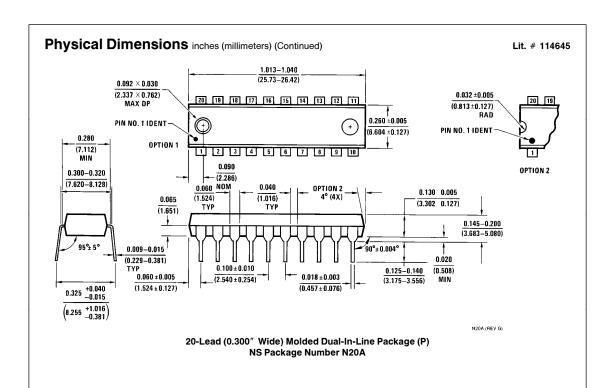
Ordering Information

The device number is used to form part of a simplified purchasing code where a package type and temperature range are defined as follows:

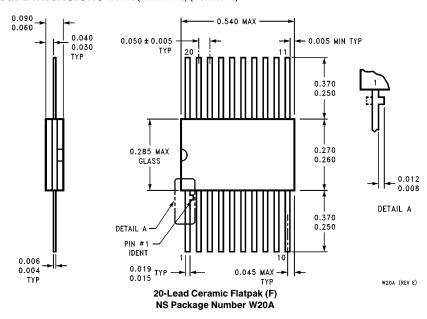








Physical Dimensions inches (millimeters) (Continued)



LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Corporation 2900 Semiconductor Drive P.O. Box 58090 Santa Clara, CA 95052-8090 Tei: 1(800) 272-9959 TWX: (910) 339-9240

 uctor
 National Semiconductor GmbH

 Drive
 Livry-Gargan-Str. 10

 D-82256 Fürstenfeldbruck
 Germany

 Tel: (81-41) 35-0
 Telex: 527649

 Fax: (81-41) 35-1
 Fax: (81-41) 35-1

National Semiconductor Japan Ltd. Sumitomo Chemical Engineering Center Bldg. 7F 1-7-1, Nakase, Mihama-Ku Chiba-City, Ciba Prefecture 261

National Semiconductor Hong Kong Ltd. 13th Floor, Straight Block, Ocean Centre, 5 Canton Rd. Tsimshatsui, Kowloon Hong Kong Tel: (852) 2737-1600 Fax: (852) 2736-9960 National Semiconductores Do Brazil Ltda. Rue Deputado Lacorda Franco 120-3A Sao Paulo-SP Brazil 05418-000 Tel: (55-11) 212-5066 Telex: 391-1131931 NSBR BR Fax: (55-11) 212-1181 National Semiconductor (Australia) Pty, Ltd. Building 16 Business Park Drive Monash Business Park Nottinghill, Melbourne Victoria 3168 Australia Tel: (3) 558-9999 Fax: (3) 558-9998